

Title (en)
HEAT-DISSIPATION MEMBER, MANUFACTURING METHOD THEREFOR, AND BATTERY MODULE COMPRISING HEAT-DISSIPATION MEMBER

Title (de)
WÄRMEABLEITENDES ELEMENT, HERSTELLUNGSVERFAHREN DAFÜR UND BATTERIEMODUL MIT WÄRMEABLEITENDEM ELEMENT

Title (fr)
ÉLÉMENT DE DISSIPATION DE CHALEUR, SON PROCÉDÉ DE FABRICATION, ET MODULE DE BATTERIE COMPRENANT UN ÉLÉMENT DE DISSIPATION DE CHALEUR

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Abstract (en)
Provided are a heat dissipation material, a method of manufacturing the same, and a battery module including the same. The heat dissipation material according to an embodiment of the present disclosure may include: a plurality of foam pad members provided to be capable of buffering; and a graphite member configured to surround the foam pad member for heat conduction, wherein the graphite member is provided to surround the plurality of foam pad members, respectively.

IPC 8 full level
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